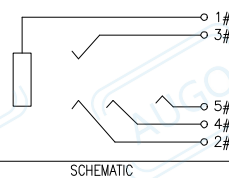
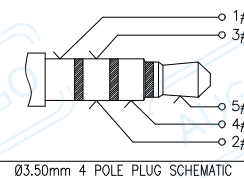
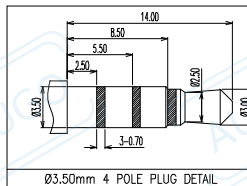
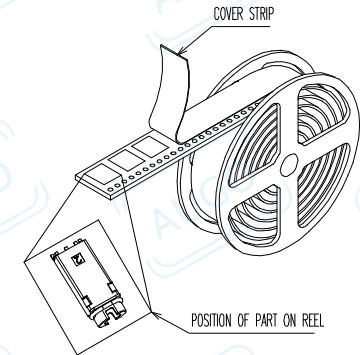
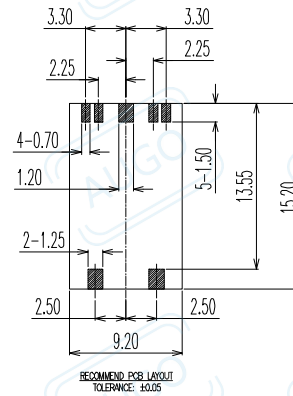
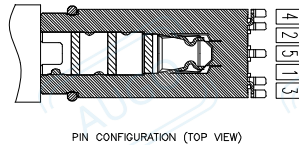
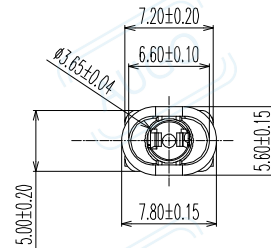
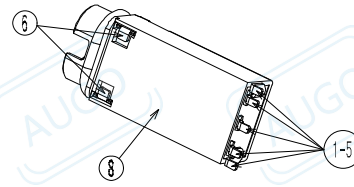




NOTES

1. CURRENT RATING: 1A.
2. CONTACT RESISTANCE: 50mΩ MAX.
3. INSULATION RESISTANCE: 100MΩ MIN.
4. DIELECTRIC WITHSTANDING: 500V AC MIN.
5. DURABILITY: 5000 CYCLES MIN.
6. CONNECTOR MATING FORCES: 3~30N.
7. CONNECTOR UNMATING FORCES: 3~30N.
8. OPERATING TEMPERATURE: -25°C TO +85°C.
9. WATERPROOF LEVEL: IP68



⑩	GLUE	1	EPOXY RESIN ADHESIVE	BLACK (SL407-DN)
⑨	O-RING	1	SILICONE RUBBER Ø0.8	RED
⑧	COVER	1	PA9T-G1350H, UL 94V-0	BLACK
⑦	HOUSING	1	PA9T G1350H, UL 94V-0	BLACK
⑥	TERMINAL 6#(HOLD DOWN)	2	C5210-EH, 0.25T	ALL OVER NICKEL 50u" MIN
⑤	TERMINAL 5#(TIP SPRING)	1	C5210-EH, 0.25T	ALL OVER 50u" Ni, Au 2u" MIN ON CONTACT AREA, Au 1u" MIN ON SOLDER AREA
④	TERMINAL 4#(RING SPRING)	1	C5210-EH, 0.25T	ALL OVER 50u" Ni, Au 2u" MIN ON CONTACT AREA, Au 1u" MIN ON SOLDER AREA
③	TERMINAL 3#(SLEEVE SPRING 3)	1	C5210-EH, 0.25T	ALL OVER 50u" Ni, Au 2u" MIN ON CONTACT AREA, Au 1u" MIN ON SOLDER AREA
②	TERMINAL 2#(SLEEVE SPRING 2)	1	C5210-EH, 0.25T	ALL OVER 50u" Ni, Au 2u" MIN ON CONTACT AREA, Au 1u" MIN ON SOLDER AREA
①	TERMINAL 1#(SLEEVE SPRING 1)	1	C5210-EH, 0.25T	ALL OVER 50u" Ni, Au 2u" MIN ON CONTACT AREA, Au 1u" MIN ON SOLDER AREA
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

DONGGUAN AUGO ELECTRONICS CO.,LTD.

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PART NAME		WATERPROOF Ø3.5 PHONE JACK				DRAWING	Y,C,ZHANG	DWG.No.	
PART NO.		PJ-3594S-WP				CHECK	G.C.Chen	REV.	A1
	UNIT :	TOLERANCE OTHERWISE	UP TO 5	±0.2	ANGLE	APPROVAL	DATE		03-06-2025
	mm		ABOVE 5 ~30	±0.3		ABOVE 30	±0.5	SCALE	1:1
			ANGLE	±3°					